

8-BIT ADDRESSABLE LATCH

The SN54/74LS259 is a high-speed 8-Bit Addressable Latch designed for general purpose storage applications in digital systems. It is a multifunctional device capable of storing single line data in eight addressable latches, and also a 1-of-8 decoder and demultiplexer with active HIGH outputs. The device also incorporates an active LOW common Clear for resetting all latches, as well as, an active LOW Enable.

- Serial-to-Parallel Conversion
- Eight Bits of Storage With Output of Each Bit Available
- Random (Addressable) Data Entry
- · Active High Demultiplexing or Decoding Capability
- Easily Expandable
- Common Clear

CONNECTION DIAGRAM DIP (TOP VIEW)



PIN NAMES		LOADING	LOADING (Note a)				
		HIGH	LOW				
A ₀ , A ₁ , A ₂	Address Inputs	0.5 U.L.	0.25 U.L.				
D	Data Input	0.5 U.L.	0.25 U.L.				
<u>E</u>	Enable (Active LOW) Input	1.0 U.L.	0.5 U.L.				
С	Clear (Active LOW) input	0.5 U.L.	0.25 U.L.				
Q ₀ to Q ₇	Parallel Latch Outputs (Note b)	10 U.L.	5 (2.5) U.L.				

NOTES:

a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

b) The Output LOW drive factor is 2.5 U.L. for Military (54) and 5 U.L. for Commercial

(74) Temperature Ranges.

GUARANTEED OPERATING RANGES

Symbol	Parameter		Min	Тур	Max	Unit
VCC	Supply Voltage	54 74	4.5 4.75	5.0 5.0	5.5 5.25	V
Т _А	Operating Ambient Temperature Range	54 74	-55 0	25 25	125 70	°C
ЮН	Output Current — High	54, 74			-0.4	mA
IOL	Output Current — Low	54 74			4.0 8.0	mA

SN54/74LS259

8-BIT ADDRESSABLE LATCH

LOW POWER SCHOTTKY



LOGIC DIAGRAM



FUNCTIONAL DESCRIPTION

The SN54/74LS259 has four modes of operation as shown in the mode selection table. In the addressable latch mode, data on the Data line (D) is written into the addressed latch.The addressed latch will follow the data input with all non-addressed latches remaining in their previous states. In the memory mode, all latches remain in their previous state and are unaffected by the Data or Address inputs.

In the one-of-eight decoding or demultiplexing mode, the

addressed output will follow the state of the D input with all other inputs in the LOW state. In the clear mode all outputs are LOW and unaffected by the address and data inputs.

When operating the SN54/74LS259 as an addressable latch, changing more then one bit of the address could impose a transient wrong address. Therefore, this should only be done while in the memory mode.

The truth table below summarizes the operations.

TRUTH TABLE

		MODE SELECTION							PRESE	INT OU	TPUT S	TATES	5			
Е	С	MODE	С	ΕD	A ₀	A ₁	A ₂	Q ₀	Q ₁	Q ₂	Q3	Q4	Q5	Q ₆	Q7	MODE
L H L H	H L L	Addressable Latch Memory Active HIGH Eight-Channel Demultiplexer Clear		H X L L	X L L H	X L L L • •	X L L L	L L L L	L L L H		L L L • •	L L L L	L L L L	L L L L	L L L	Clear Demultiplex
				•• L H Н X	-	н Н Х	H X	L Q _{N-1}	L	L	• L	L	L	L	H	Memory
¥ -	Don'	t Care Condition	н н н н н н н н н н н н н е • • • •	L H L L	L H H	L L L •	L L L	L H Q _{N-1} Q _{N-1}	Q _{N-1} Q _{N-1} L H	Q _{N-1} Q _{N-1}	Q _{N-1} -					Addressable Latch
L = H =	LOW HIGI	Voltage Level I Voltage Level Previous Output State	• H H	• • L L L H	H H	● H H	H H				•		>	Q _{N-1} Q _{N-1}	L H	

MODE SELECTION

FAST AND LS TTL DATA

SN54/74LS259

				Limits					
Symbol	Parameter		Min	Тур	Max	Unit	Tes	st Conditions	
VIH	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs		
Ma		54			0.7	v	Guaranteed Input	LOW Voltage for	
VIL	Input LOW Voltage	74			0.8	v	All Inputs		
VIK	Input Clamp Diode Voltage			-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} = -18 \text{ mA}$		
M		54	2.5	3.5		V	V _{CC} = MIN, I _{OH} = MAX, V _{IN} = V _{IH}		
VOH	Output HIGH Voltage	74	2.7	3.5		V	or VIL per Truth T	ble	
Max		54, 74		0.25	0.4	V	$I_{OL} = 4.0 \text{ mA}$ $V_{CC} = V_{CC} \text{ MIN},$		
VOL	Output LOW Voltage	74		0.35	0.5	V	I _{OL} = 8.0 mA	VIN = VIL or VIH per Truth Table	
		•			20	μA	$V_{CC} = MAX, V_{IN}$	= 2.7 V	
lιΗ	Input HIGH Current	Input HIGH Current			0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V		
۱ _{IL}	Input LOW Current				-0.4	mA	V _{CC} = MAX, V _{IN} = 0.4 V		
los	Short Circuit Current (Note	Short Circuit Current (Note 1)			-100	mA	V _{CC} = MAX		
ICC	Power Supply Current	^r Current			36	mA	V _{CC} = MAX		

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (T_A = 25°C, V_{CC} = 5.0 V)

		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
^t PLH ^t PHL	Turn-Off Delay, Enable to Output Turn-On Delay, Enable to Output		22 15	35 24	ns ns	
^t PLH ^t PHL	Turn-Off Delay, Data to Output Turn-On Delay, Data to Output		20 13	32 21	ns ns	C _L = 15 pF
^t PLH ^t PHL	Turn-Off Delay, Address to Output Turn-On Delay, Address to Output		24 18	38 29	ns ns	
^t PHL	Turn-On Delay, Clear to Output		17	27	ns	

AC SET-UP REQUIREMENTS (T_A = 25° C, V_{CC} = 5.0 V)

		Limits			
Symbol	Parameter	Min	Тур	Max	Unit
ts	Input Setup Time	20			ns
t _W	Pulse Width, Clear or Enable	15			ns
t _h	Hold Time, Data	5.0			ns
th	Hold Time, Address	20			ns

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AC WAVEFORMS



OTHER CONDITIONS: \overline{C} = H, A = STABLE





OTHER CONDITIONS: $\overline{E} = L, \overline{C} = H, A = STABLE$

Figure 2. Turn-on and Turn-off Delays, Data to Output



OTHER CONDITIONS: $\overline{E} = L, \overline{C} = L, D = H$

Figure 3. Turn-on and Turn-off Delays, Address to Output

1.3 V

Figure 5. Turn-on Delay, Clear to Output



OTHER CONDITIONS: $\overline{C} = H$, A = STABLE

Figure 4. Setup and Hold Time, Data to Enable



OTHER CONDITIONS: $\overline{C} = H$

Figure 6. Setup Time, Address to Enable (See Notes 1 and 2)

NOTES:

С

Q

OTHER CONDITIONS: E = H

1. The Address to Enable Setup Time is the time before the HIGH-to-LOW Enable transition that the Address must be stable so that the correct latch is addressed and the other latches are not affected.

2. The shaded areas indicate when the inputs are permitted to change for predictable output performance.

^tPHL

1.3 V

Case 751B-03 D Suffix **16-Pin Plastic** SO-16



Case 648-08 N Suffix **16-Pin Plastic**





- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER. DIMENSION A AND B DO NOT INCLUDE MOLD 2 3.
- PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 (0.006) 4.
- PER SIDE. 751B-01 IS OBSOLETE, NEW STANDARD 751B-03. 5.

	MILLIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
М	0°	7 °	0°	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2.
- CONTROLLING DIMENSION: INCH. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL. 3.
- DIMENSION "B" DOES NOT INCLUDE MOLD 4. FLASH.
- 5.
- ROUNDED CORNERS OPTIONAL. 648-01 THRU -07 OBSOLETE, NEW STANDARD 6. 648-08.

	MILLIM	ETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	18.80	19.55	0.740	0.770		
В	6.35	6.85	0.250	0.270		
С	3.69	4.44	0.145	0.175		
D	0.39	0.53	0.015	0.021		
F	1.02	1.77	0.040	0.070		
G	2.54	BSC	0.100 BSC			
н	1.27	BSC	0.050 BSC			
J	0.21	0.38	0.008	0.015		
K	2.80	3.30	0.110	0.130		
L	7.50	7.74	0.295	0.305		
М	0°	10°	0°	10°		
S	0.51	1.01	0.020	0.040		

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL 4. DIM F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY. 5. 620-01 THRU -08 OBSOLETE, NEW STANDARD 620-09.

- 620-09.

	MILLIM	ETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	19.05	19.55	0.750	0.770			
В	6.10	7.36	0.240	0.290			
С	_	4.19	-	0.165			
D	0.39	0.53	0.015	0.021			
E	1.27	BSC	0.050 BSC				
F	1.40	1.77	0.055	0.070			
G	2.54	BSC	0.100	BSC			
J	0.23	0.27	0.009	0.011			
K	_	5.08	_	0.200			
L	7.62	7.62 BSC		BSC			
M	0°	15°	0°	15°			
N	0.39	0.88	0.015	0.035			

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